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Hanson et al.

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(54)INDUCTOR PACKAGE

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USPC D13/117

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D13/183, 199; D21/386, 484, 491, 497,
D21/500, 503
CPC H01F 27/02; H01F 27/04; H01F 27/24;
H01F 27/26; H01F 27/28; H01F 27/29;
H01F 27/245; H01F 27/263; H01F
27/292; H01F 27/325; H01F 41/06; H01F
41/076; H01F 41/0233; H01F 41/0246;
H02K 5/16; H02M 3/28
See application file for complete search history.

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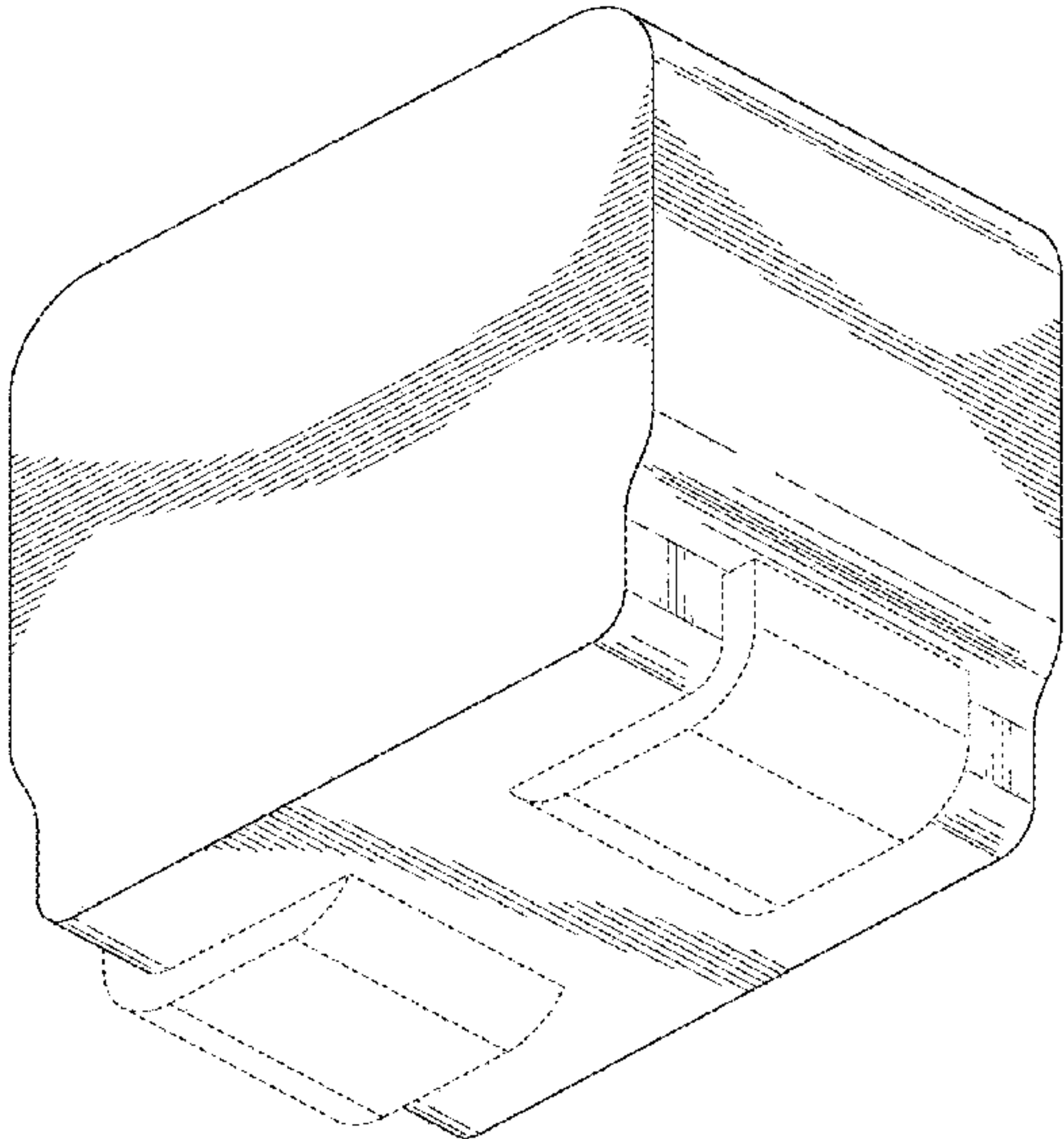
(57)CLAIM

The ornamental design for an inductor package, as shown and described.

DESCRIPTION

FIG. 1 is a top, front, right perspective view of a sixth embodiment of an inductor package in accordance with our design;
FIG. 2 is a bottom, rear, left perspective view thereof;
FIG. 3 is a front elevational view thereof;
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a right side elevational view thereof;
FIG. 6 is a left side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines represent portions of the inductor package in which the design is embodied that form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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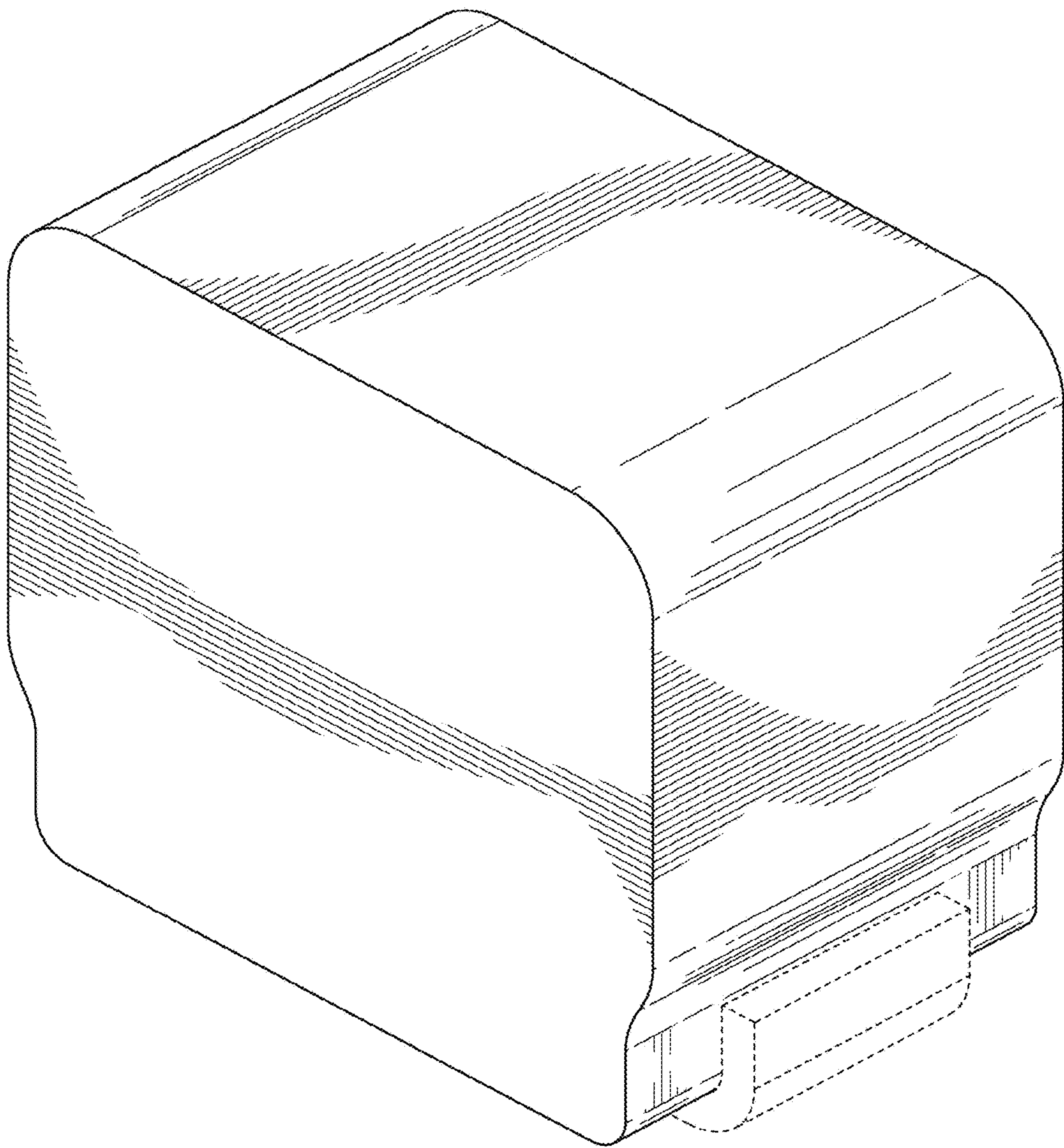


FIG. 1

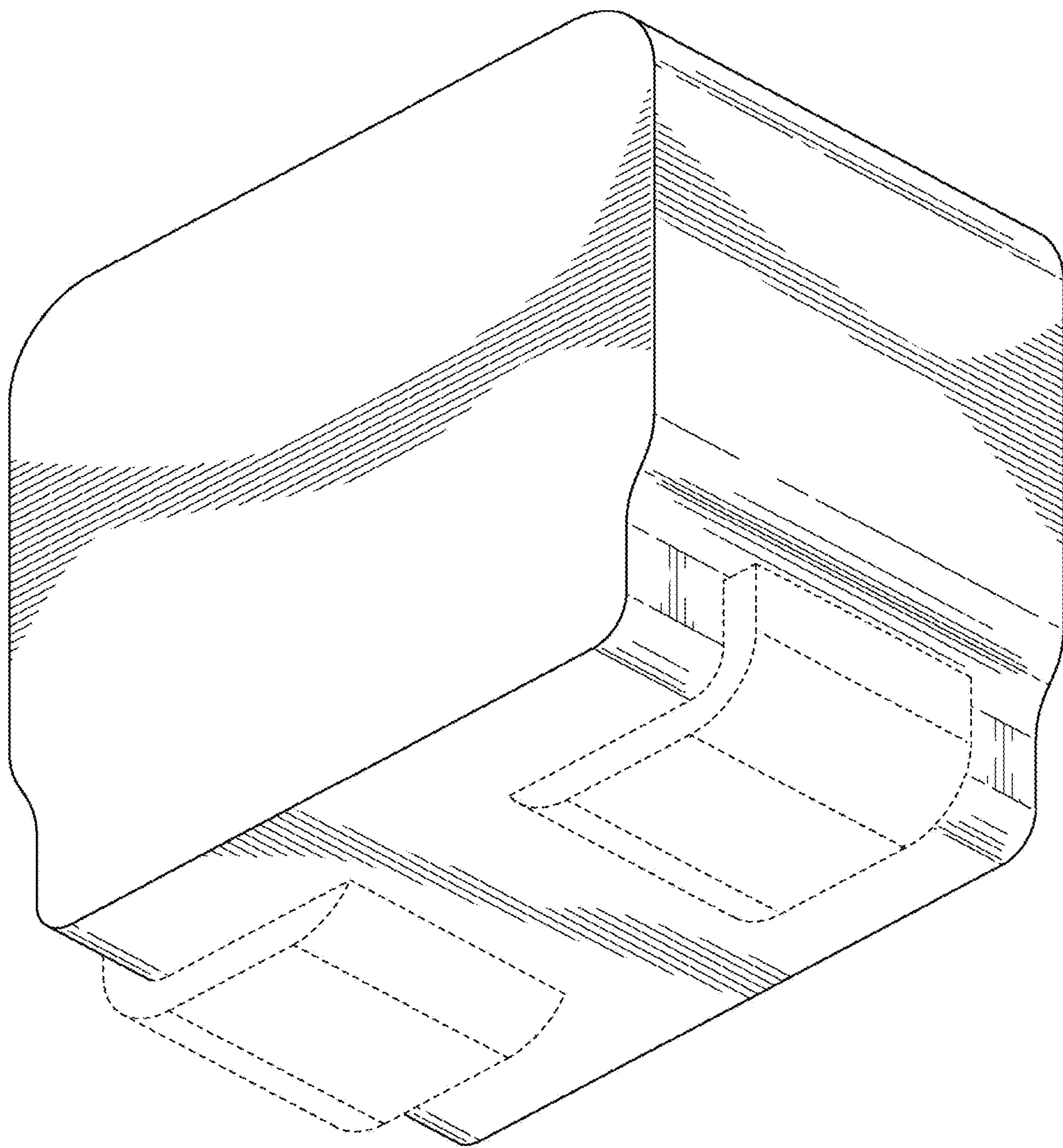


FIG. 2

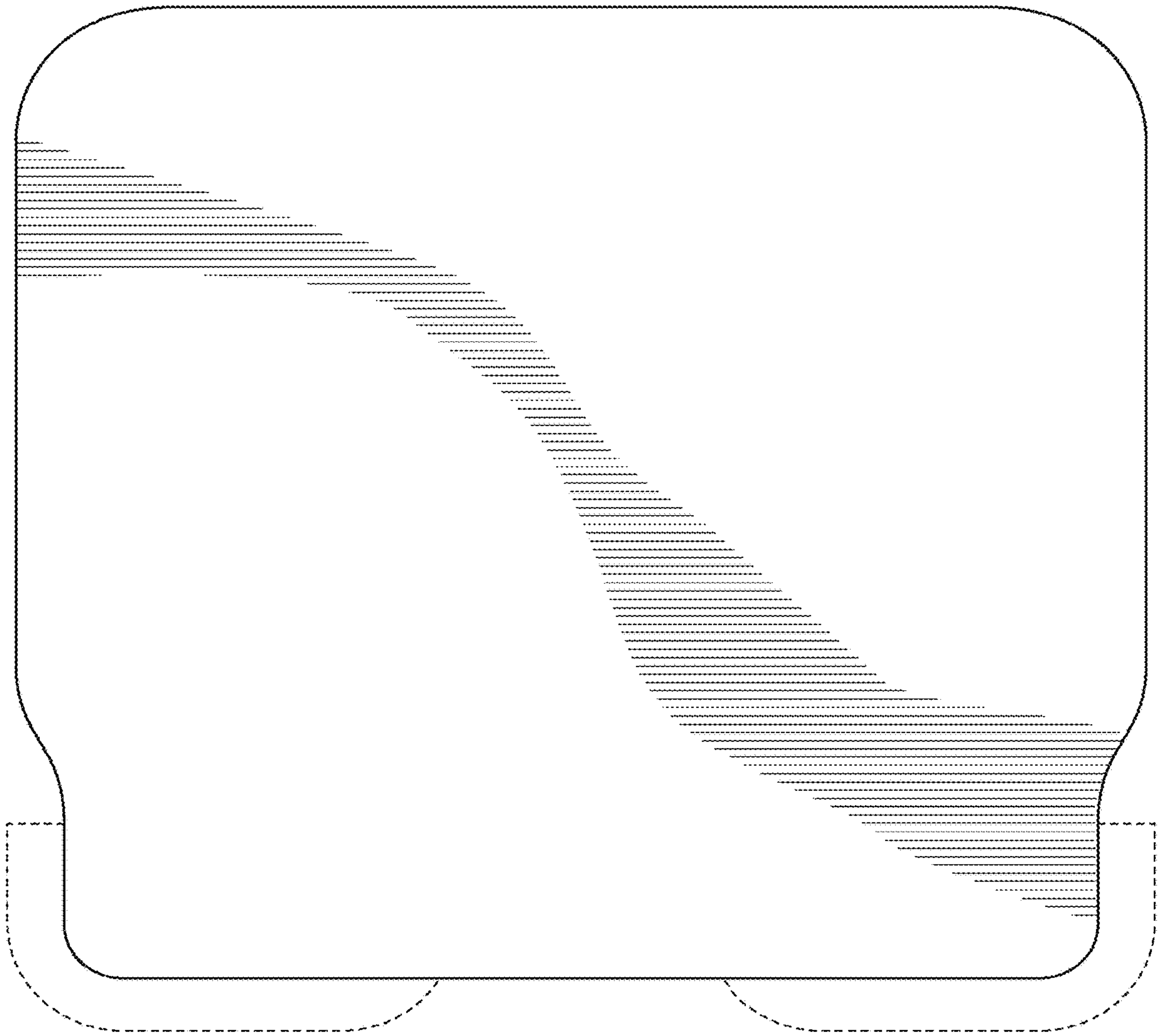


FIG. 3

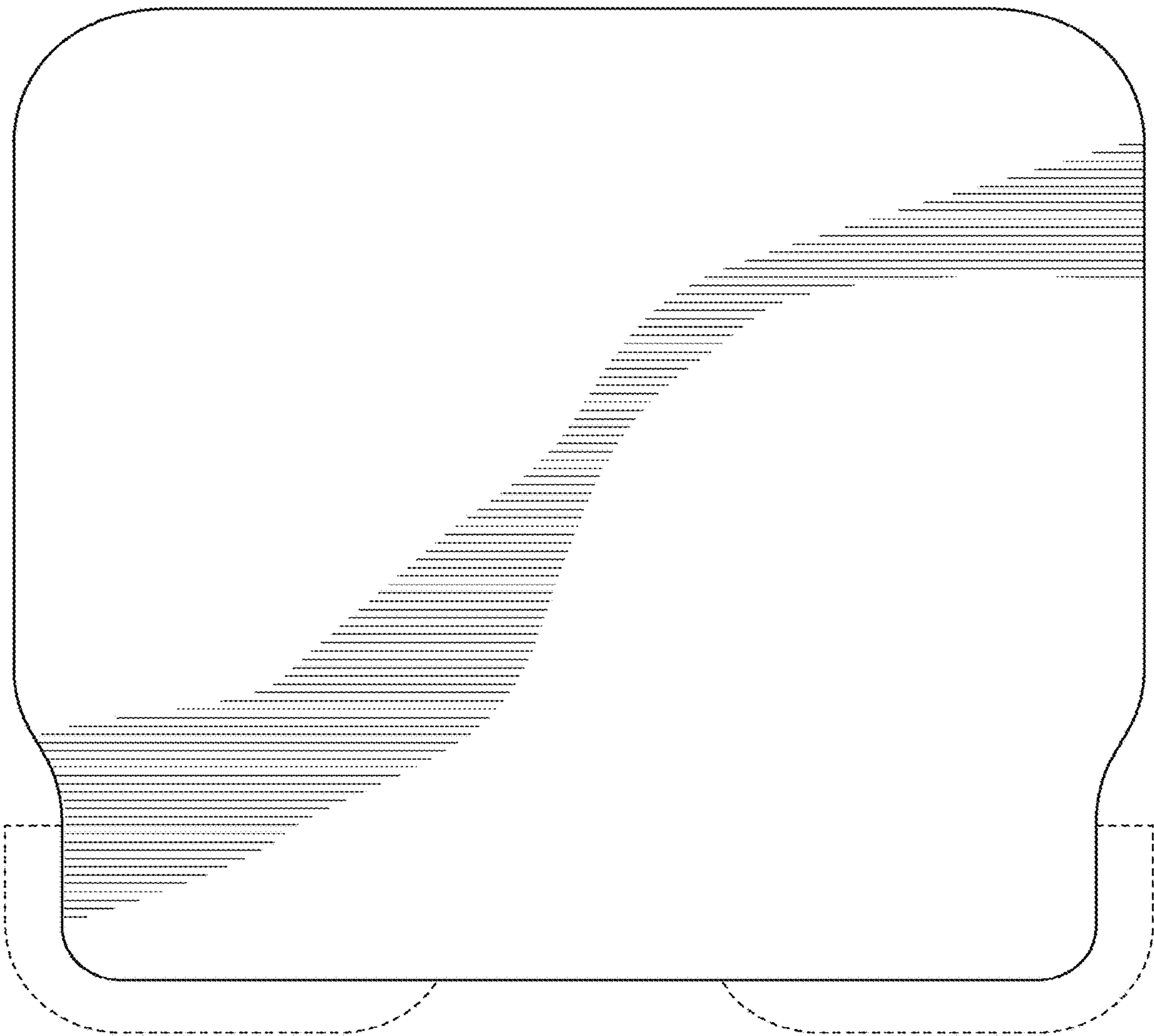


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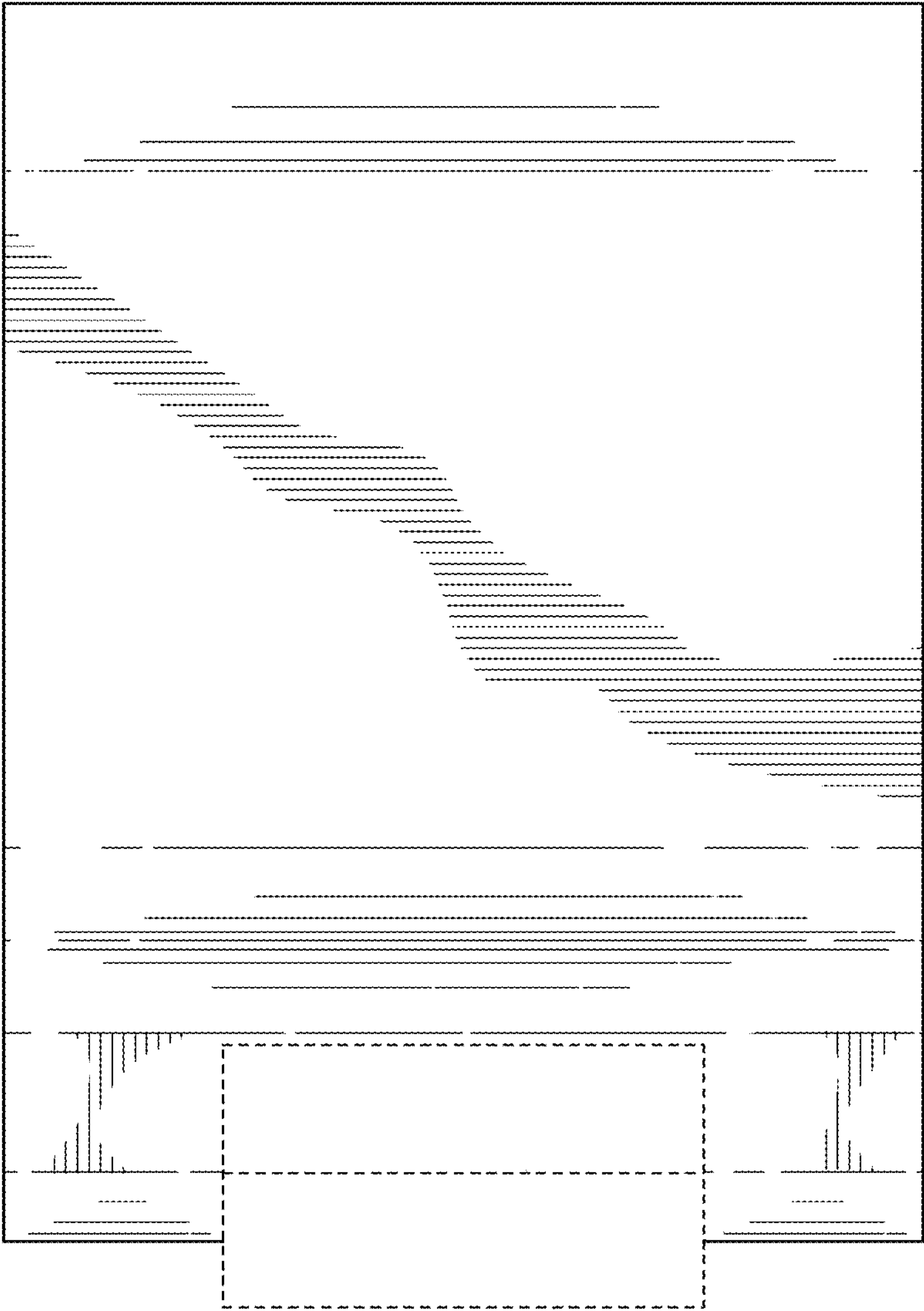


FIG. 5

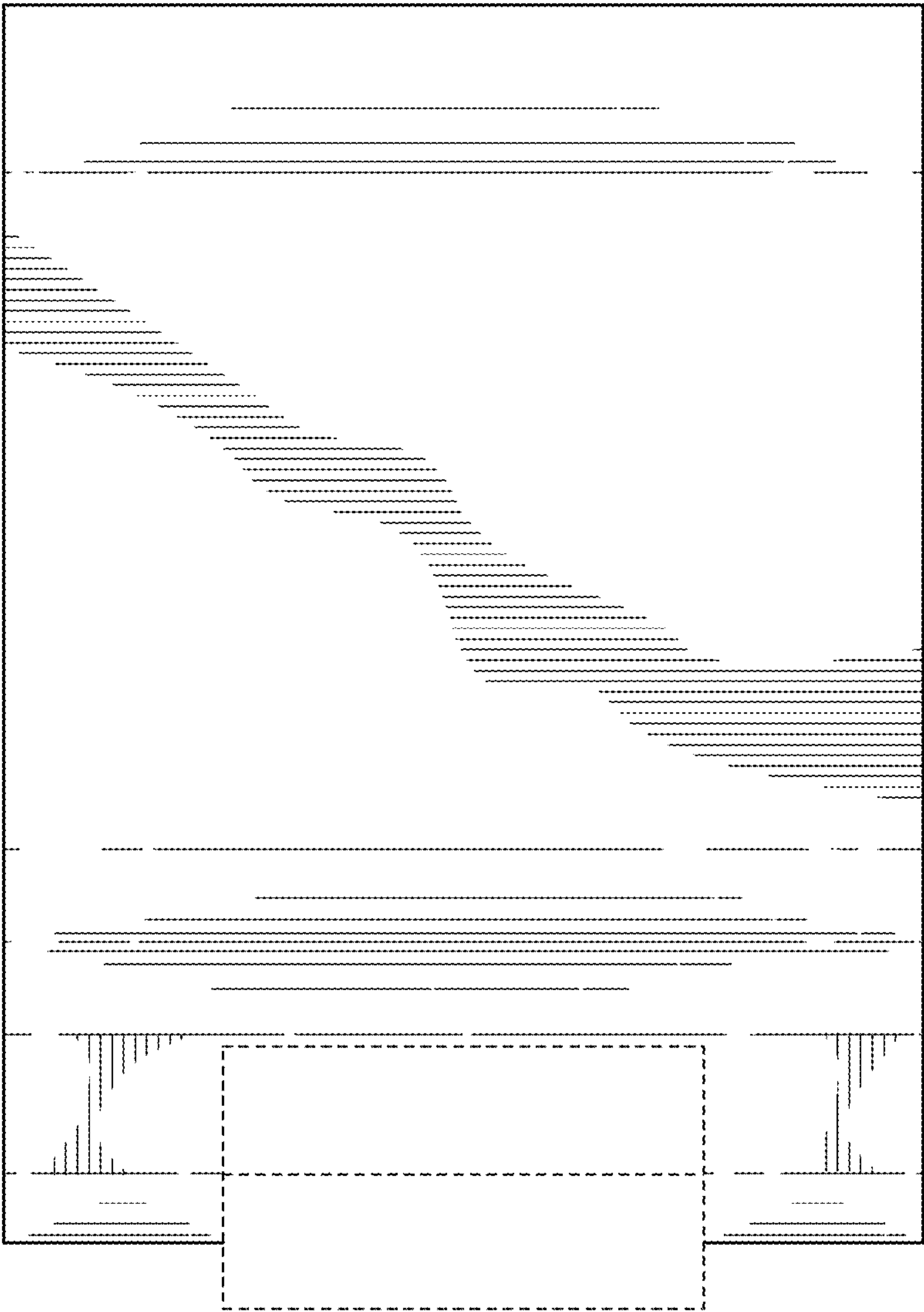


FIG. 6

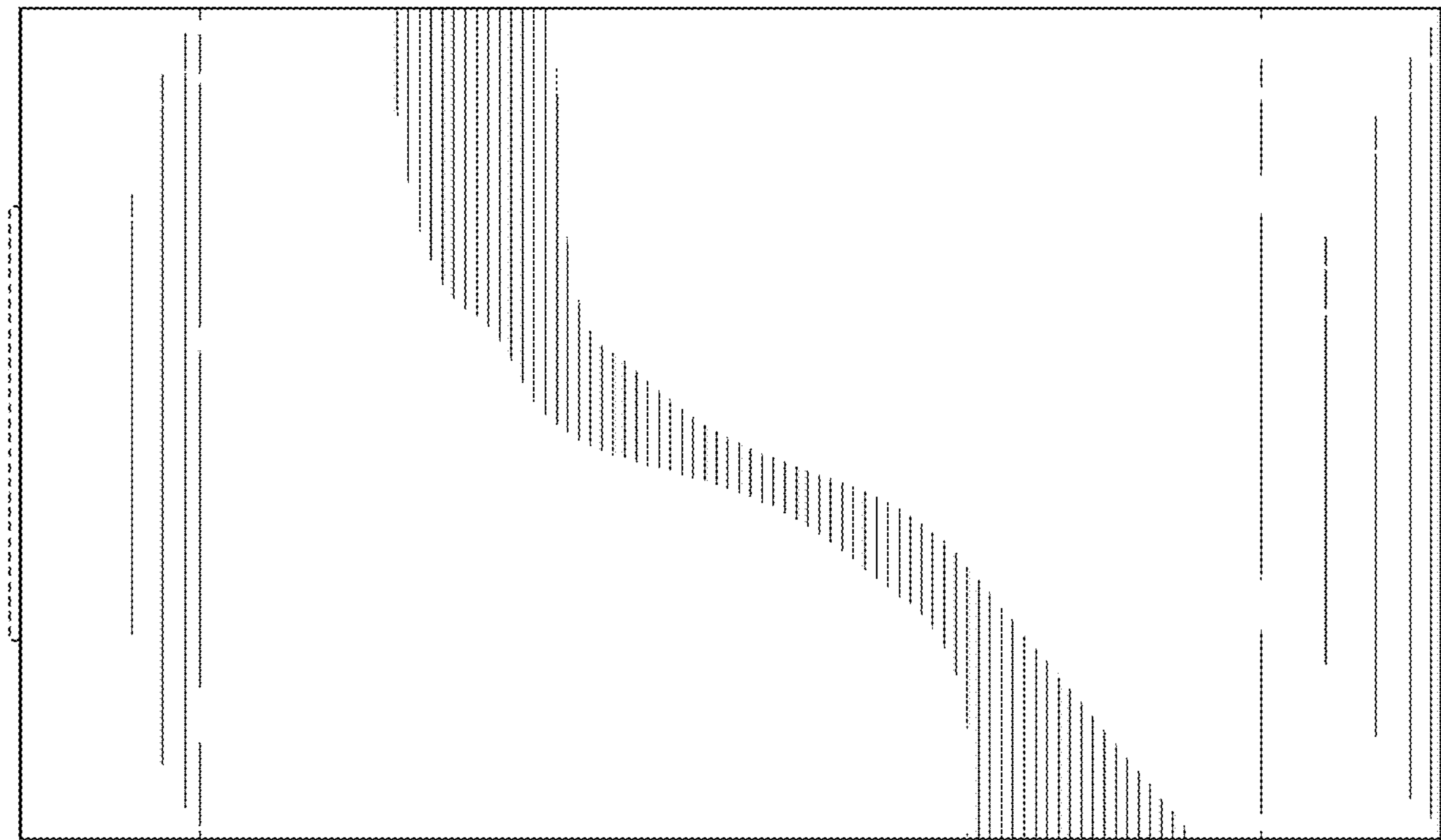


FIG. 7

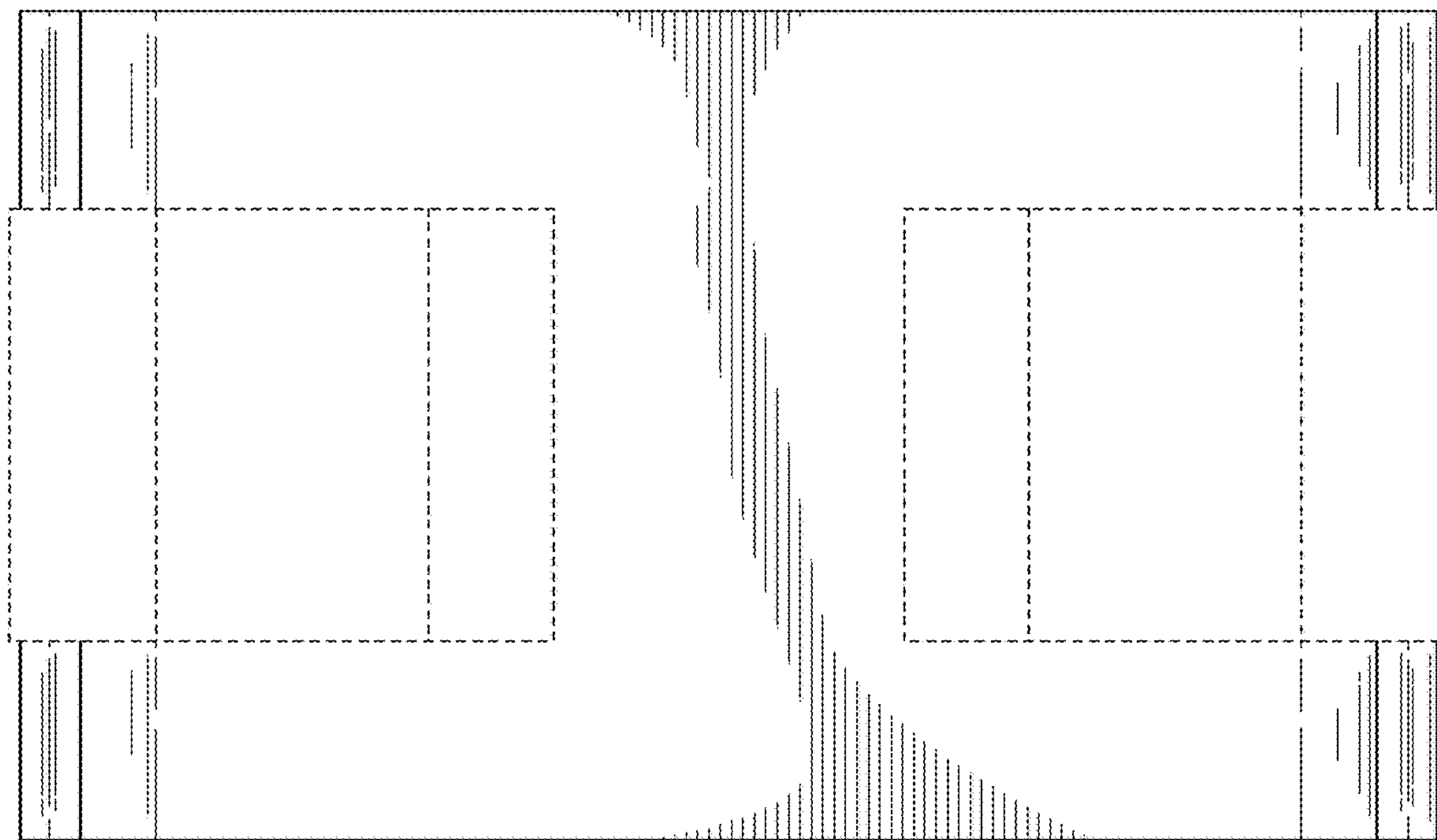


FIG. 8